

74VCX16240

Low-Voltage 1.8/2.5/3.3V 16-Bit Buffer

With 3.6 V-Tolerant Inputs and Outputs (3-State, Inverting)

The 74VCX16240 is an advanced performance, inverting 16-bit buffer. It is designed for very high-speed, very low-power operation in 1.8 V, 2.5 V or 3.3 V systems.

When operating at 2.5 V (or 1.8 V) the part is designed to tolerate voltages it may encounter on either inputs or outputs when interfacing to 3.3 V busses. It is guaranteed to be over-voltage tolerant to 3.6 V.

The 74VCX16240 is nibble controlled with each nibble functioning identically, but independently. The control pins may be tied together to obtain full 16-bit operation. The 3-state outputs are controlled by an Output Enable (\overline{OEn}) input for each nibble. When \overline{OEn} is LOW, the outputs are on. When \overline{OEn} is HIGH, the outputs are in the high impedance state.

Features

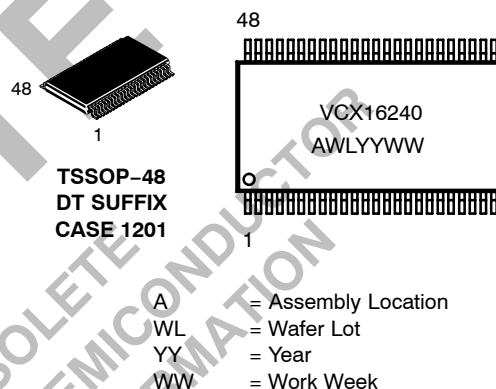
- Designed for Low Voltage Operation: $V_{CC} = 1.65\text{ V} - 3.6\text{ V}$
- 3.6V Tolerant Inputs and Outputs
- High Speed Operation: 2.5 ns max for 3.0 V to 3.6 V
3.0 ns max for 2.3 V to 2.7 V
6.0 ns max for 1.65 V to 1.95 V
- Static Drive:
 $\pm 24\text{ mA}$ Drive at 3.0 V
 $\pm 18\text{ mA}$ Drive at 2.3 V
 $\pm 6\text{ mA}$ Drive at 1.65 V
- Supports Live Insertion and Withdrawal
- I_{OFF} Specification Guarantees High Impedance When $V_{CC} = 0\text{ V}$
- Near Zero Static Supply Current in All Three Logic States (20 μA)
Substantially Reduces System Power Requirements
- Latchup Performance Exceeds $\pm 250\text{ mA}$ @ 125°C
- ESD Performance: Human Body Model >2000 V;
Machine Model >200 V
- All Devices in Package TSSOP are Inherently Pb-Free*



ON Semiconductor®

<http://onsemi.com>

MARKING DIAGRAM



ORDERING INFORMATION

Device	Package	Shipping†
74VCX16240DT	TSSOP (Pb-Free)	39 / Rail
74VCX16240DTR	TSSOP (Pb-Free)	2500 / Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

74VCX16240

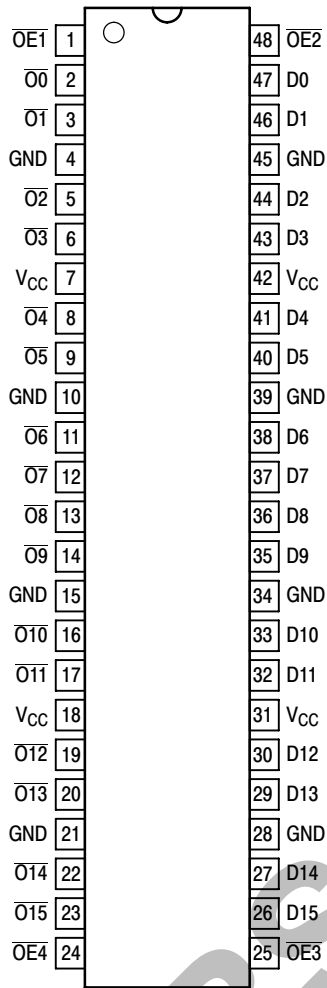


Figure 1. 48-Lead Pinout
(Top View)

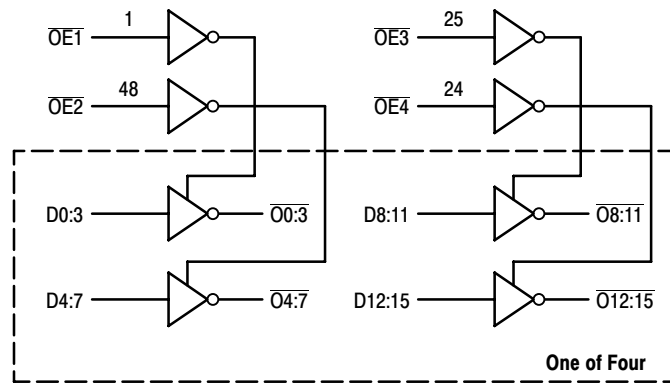


Figure 2. Logic Diagram

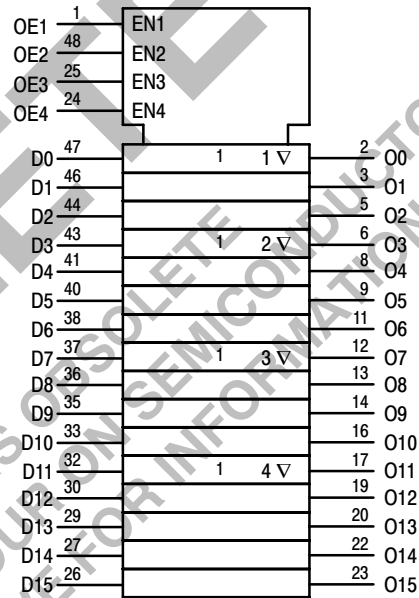


Figure 3. IEC Logic Diagram

Table 1. PIN NAMES

Pins	Function
OE _n	Output Enable Inputs
D0–D15	Inputs
O0–O15	Outputs

TRUTH TABLE

OE ₁	D0:3	O0:3	OE ₂	D4:7	O4:7	OE ₃	D8:11	O8:11	OE ₄	D12:15	O12:15
L	L	H	L	L	H	L	L	H	L	L	H
L	H	L	L	H	L	L	H	L	L	H	L
H	X	Z	H	X	Z	H	X	Z	H	X	Z

H = High Voltage Level;

L = Low Voltage Level;

Z = High Impedance State;

X = High or Low Voltage Level and Transitions Are Acceptable, for I_{CC} reasons, DO NOT FLOAT Inputs

74VCX16240

ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Condition	Unit
V_{CC}	DC Supply Voltage	-0.5 to +4.6		V
V_I	DC Input Voltage	$-0.5 \leq V_I \leq +4.6$		V
V_O	DC Output Voltage	$-0.5 \leq V_O \leq +4.6$	Output in 3-State	V
		$-0.5 \leq V_O \leq V_{CC} + 0.5$	Note 1; Outputs Active	V
I_{IK}	DC Input Diode Current	-50	$V_I < GND$	mA
I_{OK}	DC Output Diode Current	-50	$V_O < GND$	mA
		+50	$V_O > V_{CC}$	mA
I_O	DC Output Source/Sink Current	± 50		mA
I_{CC}	DC Supply Current Per Supply Pin	± 100		mA
I_{GND}	DC Ground Current Per Ground Pin	± 100		mA
T_{STG}	Storage Temperature Range	-65 to +150		$^{\circ}C$

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. I_O absolute maximum rating must be observed.

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Min	Typ	Max	Unit	
V_{CC}	Supply Voltage	Operating	1.65	3.3	3.6	V
		Data Retention Only	1.2	3.3	3.6	
V_I	Input Voltage	-0.3		3.6	V	
V_O	Output Voltage	(Active State)	0		V_{CC}	V
		(3-State)	0		3.6	
I_{OH}	HIGH Level Output Current, $V_{CC} = 3.0\text{ V} - 3.6\text{ V}$			-24	mA	
I_{OL}	LOW Level Output Current, $V_{CC} = 3.0\text{ V} - 3.6\text{ V}$			24	mA	
I_{OH}	HIGH Level Output Current, $V_{CC} = 2.3\text{ V} - 2.7\text{ V}$			-18	mA	
I_{OL}	LOW Level Output Current, $V_{CC} = 2.3\text{ V} - 2.7\text{ V}$			18	mA	
I_{OH}	HIGH Level Output Current, $V_{CC} = 1.65\text{ V} - 1.95\text{ V}$			-6	mA	
I_{OL}	LOW Level Output Current, $V_{CC} = 1.65\text{ V} - 1.95\text{ V}$			6	mA	
T_A	Operating Free-Air Temperature	-40		+85	$^{\circ}C$	
$\Delta t/\Delta V$	Input Transition Rise or Fall Rate, V_{IN} from 0.8 V to 2.0 V, $V_{CC} = 3.0\text{ V}$	0		10	ns/V	

74VCX16240

DC ELECTRICAL CHARACTERISTICS

Symbol	Characteristic	Condition	T _A = -40°C to +85°C		Unit
			Min	Max	
V _{IH}	HIGH Level Input Voltage (Note 2)	1.65 V ≤ V _{CC} < 2.3 V	0.65 x V _{CC}		V
		2.3 V ≤ V _{CC} ≤ 2.7 V	1.6		
		2.7 V < V _{CC} ≤ 3.6 V	2.0		
V _{IL}	LOW Level Input Voltage (Note 2)	1.65 V ≤ V _{CC} < 2.3 V		0.35 x V _{CC}	V
		2.3 V ≤ V _{CC} ≤ 2.7 V		0.7	
		2.7 V < V _{CC} ≤ 3.6 V		0.8	
V _{OH}	HIGH Level Output Voltage	1.65 V ≤ V _{CC} ≤ 3.6 V; I _{OH} = -100 μA	V _{CC} - 0.2		V
		V _{CC} = 1.65 V; I _{OH} = -6 mA	1.25		
		V _{CC} = 2.3 V; I _{OH} = -6 mA	2.0		
		V _{CC} = 2.3 V; I _{OH} = -12 mA	1.8		
		V _{CC} = 2.3 V; I _{OH} = -18 mA	1.7		
		V _{CC} = 2.7 V; I _{OH} = -12 mA	2.2		
		V _{CC} = 3.0 V; I _{OH} = -18 mA	2.4		
		V _{CC} = 3.0 V; I _{OH} = -24 mA	2.2		
V _{OL}	LOW Level Output Voltage	1.65 V ≤ V _{CC} ≤ 3.6 V; I _{OL} = 100 μA		0.2	V
		V _{CC} = 1.65 V; I _{OL} = 6 mA		0.3	
		V _{CC} = 2.3 V; I _{OL} = 12 mA		0.4	
		V _{CC} = 2.3 V; I _{OL} = 18 mA		0.6	
		V _{CC} = 2.7 V; I _{OL} = 12 mA		0.4	
		V _{CC} = 3.0 V; I _{OL} = 18 mA		0.4	
		V _{CC} = 3.0 V; I _{OL} = 24 mA		0.55	
I _I	Input Leakage Current	1.65 V ≤ V _{CC} ≤ 3.6 V, 0 V ≤ V _I ≤ 3.6 V		±5.0	μA
I _{OZ}	3-State Output Current	1.65 V ≤ V _{CC} ≤ 3.6 V; 0 V ≤ V _O ≤ 3.6 V; V _I = V _{IH} or V _{IL}		±10	μA
I _{OFF}	Power-Off Leakage Current	V _{CC} = 0 V; V _I or V _O = 3.6 V		10	μA
I _{CC}	Quiescent Supply Current (Note 3)	1.65 V ≤ V _{CC} ≤ 3.6 V; V _I = GND or V _{CC}		20	μA
		1.65 V ≤ V _{CC} ≤ 3.6 V; 3.6 V ≤ V _I , V _O ≤ 3.6 V		±20	μA
ΔI _{CC}	Increase in I _{CC} per Input	2.7 V < V _{CC} ≤ 3.6 V; V _{IH} = V _{CC} - 0.6 V		750	μA

2. These values of V_I are used to test DC electrical characteristics only.

3. Outputs disabled or 3-state only.

74VCX16240

AC CHARACTERISTICS (Note 4; $t_R = t_F = 2.0$ ns; $C_L = 30$ pF; $R_L = 500$ Ω)

Symbol	Parameter	Waveform	$T_A = -40^\circ\text{C to } +85^\circ\text{C}$						Unit
			$V_{CC} = 3.0\text{ V to } 3.6\text{ V}$		$V_{CC} = 2.3\text{ V to } 2.7\text{ V}$		$V_{CC} = 1.65\text{ to } 1.95\text{ V}$		
			Min	Max	Min	Max	Min	Max	
t_{PLH} t_{PHL}	Propagation Delay Input to Output	1	0.8 0.8	2.5 2.5	1.0 1.0	3.0 3.0	1.5 1.5	6.0 6.0	ns
t_{PZH} t_{PZL}	Output Enable Time to High and Low Level	2	0.8 0.8	3.5 3.5	1.0 1.0	4.1 4.1	1.5 1.5	8.2 8.2	ns
t_{PHZ} t_{PLZ}	Output Disable Time From High and Low Level	2	0.8 0.8	3.5 3.5	1.0 1.0	3.8 3.8	1.5 1.5	7.8 7.8	ns
t_{OSHL} t_{OSLH}	Output-to-Output Skew (Note 5)			0.5 0.5		0.5 0.5		0.75 0.75	ns

- For $C_L = 50$ pF, add approximately 300 ps to the AC maximum specification.
- Skew is defined as the absolute value of the difference between the actual propagation delay for any two separate outputs of the same device. The specification applies to any outputs switching in the same direction, either HIGH-to-LOW (t_{OSHL}) or LOW-to-HIGH (t_{OSLH}); parameter guaranteed by design.

AC CHARACTERISTICS ($t_R = t_F = 2.0$ ns; $C_L = 50$ pF; $R_L = 500$ Ω)

Symbol	Parameter	Waveform	$T_A = -40^\circ\text{C to } +85^\circ\text{C}$				Unit
			$V_{CC} = 3.0\text{ V to } 3.6\text{ V}$		$V_{CC} = 2.7\text{ V}$		
			Min	Max	Min	Max	
t_{PLH} t_{PHL}	Propagation Delay Input to Output	3	1.0 1.0	3.9 3.9		5.3 5.3	ns
t_{PZH} t_{PZL}	Output Enable Time to High and Low Level	4	1.0 1.0	5.0 5.0		6.1 6.1	ns
t_{PHZ} t_{PLZ}	Output Disable Time From High and Low Level	4	1.0 1.0	4.4 4.4		4.8 4.8	ns
t_{OSHL} t_{OSLH}	Output-to-Output Skew (Note 6)			0.5 0.5		0.5 0.5	ns

- Skew is defined as the absolute value of the difference between the actual propagation delay for any two separate outputs of the same device. The specification applies to any outputs switching in the same direction, either HIGH-to-LOW (t_{OSHL}) or LOW-to-HIGH (t_{OSLH}); parameter guaranteed by design.

74VCX16240

DYNAMIC SWITCHING CHARACTERISTICS

Symbol	Characteristic	Condition	Typical ($T_A = +25^\circ\text{C}$)	Unit
V _{OLP}	Dynamic LOW Peak Voltage (Note 7)	$V_{CC} = 1.8\text{ V}, C_L = 30\text{ pF}, V_{IH} = V_{CC}, V_{IL} = 0\text{ V}$	0.25	V
		$V_{CC} = 2.5\text{ V}, C_L = 30\text{ pF}, V_{IH} = V_{CC}, V_{IL} = 0\text{ V}$	0.6	
		$V_{CC} = 3.3\text{ V}, C_L = 30\text{ pF}, V_{IH} = V_{CC}, V_{IL} = 0\text{ V}$	0.8	
V _{OLV}	Dynamic LOW Valley Voltage (Note 7)	$V_{CC} = 1.8\text{ V}, C_L = 30\text{ pF}, V_{IH} = V_{CC}, V_{IL} = 0\text{ V}$	-0.25	V
		$V_{CC} = 2.5\text{ V}, C_L = 30\text{ pF}, V_{IH} = V_{CC}, V_{IL} = 0\text{ V}$	-0.6	
		$V_{CC} = 3.3\text{ V}, C_L = 30\text{ pF}, V_{IH} = V_{CC}, V_{IL} = 0\text{ V}$	-0.8	
V _{OHV}	Dynamic HIGH Valley Voltage (Note 8)	$V_{CC} = 1.8\text{ V}, C_L = 30\text{ pF}, V_{IH} = V_{CC}, V_{IL} = 0\text{ V}$	1.5	V
		$V_{CC} = 2.5\text{ V}, C_L = 30\text{ pF}, V_{IH} = V_{CC}, V_{IL} = 0\text{ V}$	1.9	
		$V_{CC} = 3.3\text{ V}, C_L = 30\text{ pF}, V_{IH} = V_{CC}, V_{IL} = 0\text{ V}$	2.2	

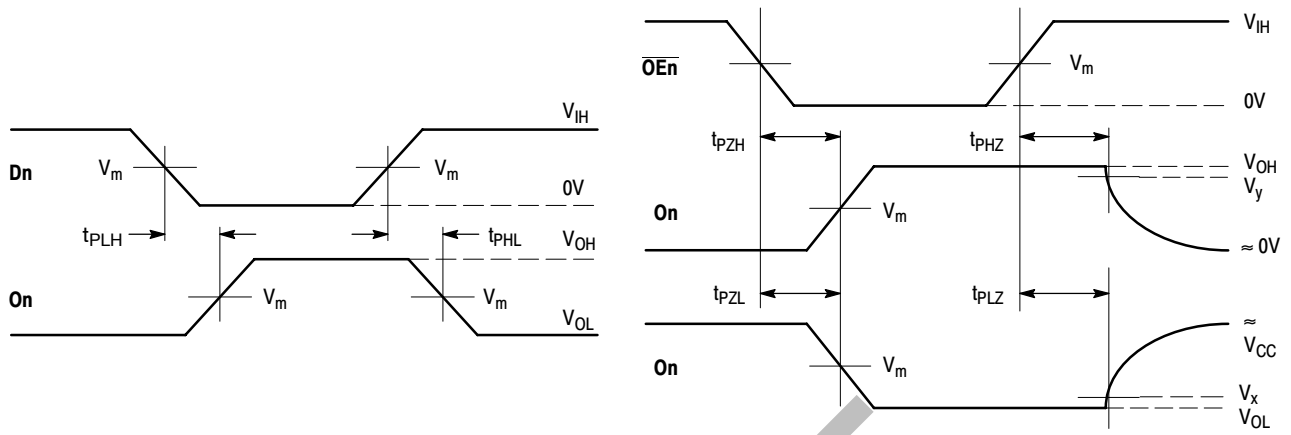
7. Number of outputs defined as "n". Measured with "n-1" outputs switching from HIGH-to-LOW or LOW-to-HIGH. The remaining output is measured in the LOW state.
8. Number of outputs defined as "n". Measured with "n-1" outputs switching from HIGH-to-LOW or LOW-to-HIGH. The remaining output is measured in the HIGH state.

CAPACITIVE CHARACTERISTICS

Symbol	Parameter	Condition	Typical	Unit
C _{IN}	Input Capacitance	Note 9	6	pF
C _{OUT}	Output Capacitance	Note 9	7	pF
C _{PD}	Power Dissipation Capacitance	Note 9, 10 MHz	20	pF

9. $V_{CC} = 1.8\text{ V}, 2.5\text{ V}$ or 3.3 V ; $V_I = 0\text{ V}$ or V_{CC} .

74VCX16240



WAVEFORM 1 - PROPAGATION DELAYS
 $t_R = t_F = 2.0$ ns, 10% to 90%; $f = 1$ MHz; $t_W = 500$ ns

WAVEFORM 2 - OUTPUT ENABLE AND DISABLE TIMES
 $t_R = t_F = 2.0$ ns, 10% to 90%; $f = 1$ MHz; $t_W = 500$ ns

Figure 4. AC Waveforms

Table 2. AC WAVEFORMS

Symbol	V_{CC}		
	$3.3\text{ V} \pm 0.3\text{ V}$	$2.5\text{ V} \pm 0.2\text{ V}$	$1.8\text{ V} \pm 0.15\text{ V}$
V_{IH}	2.7 V	V_{CC}	V_{CC}
V_m	1.5 V	$V_{CC}/2$	$V_{CC}/2$
V_x	$V_{OL} + 0.3\text{ V}$	$V_{OL} + 0.15\text{ V}$	$V_{OL} + 0.15\text{ V}$
V_y	$V_{OH} - 0.3\text{ V}$	$V_{OH} - 0.15\text{ V}$	$V_{OH} - 0.15\text{ V}$

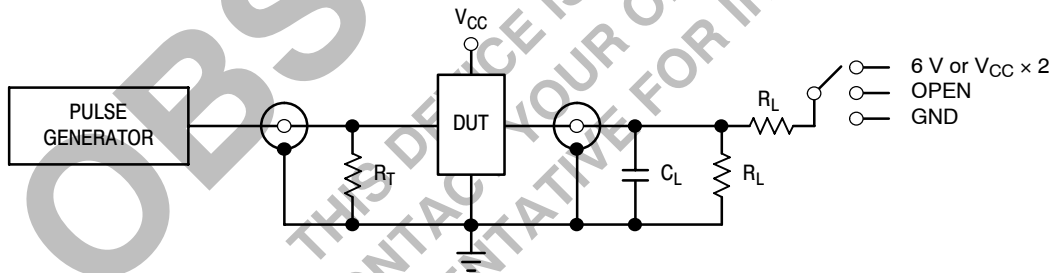


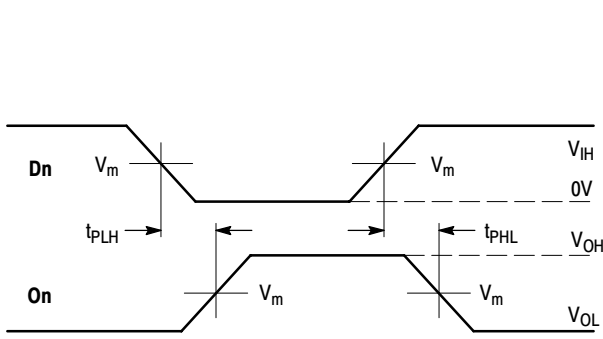
Figure 5. Test Circuit

Table 3. TEST CIRCUIT

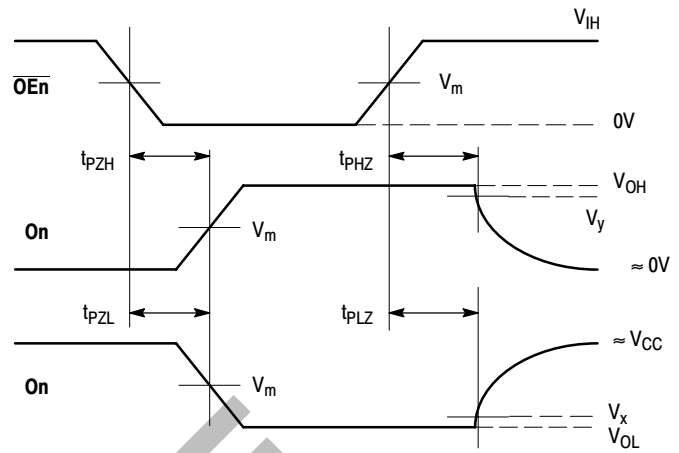
TEST	SWITCH
t_{PLH} , t_{PHL}	Open
t_{PZL} , t_{PLZ}	6 V at $V_{CC} = 3.3 \pm 0.3\text{ V}$; $V_{CC} \times 2$ at $V_{CC} = 2.5 \pm 0.2\text{ V}$; $1.8 \pm 0.15\text{ V}$
t_{PZH} , t_{PHZ}	GND

$C_L = 30$ pF or equivalent (Includes jig and probe capacitance)
 $R_L = 500$ Ω or equivalent
 $R_T = Z_{OUT}$ of pulse generator (typically 50 Ω)

74VCX16240



WAVEFORM 3 – PROPAGATION DELAYS
 $t_R = t_F = 2.0 \text{ ns}$, 10% to 90%; $f = 1 \text{ MHz}$; $t_W = 500 \text{ ns}$



WAVEFORM 4 – OUTPUT ENABLE AND DISABLE TIMES
 $t_R = t_F = 2.0 \text{ ns}$, 10% to 90%; $f = 1 \text{ MHz}$; $t_W = 500 \text{ ns}$

Figure 6. AC Waveforms

Table 4. AC WAVEFORMS

Symbol	V_{CC}	
	$3.3 \text{ V} \pm 0.3 \text{ V}$	2.7 V
V_{IH}	2.7 V	2.7 V
V_m	1.5 V	1.5 V
V_x	$V_{OL} + 0.3 \text{ V}$	$V_{OL} + 0.3 \text{ V}$
V_y	$V_{OH} - 0.3 \text{ V}$	$V_{OH} - 0.3 \text{ V}$

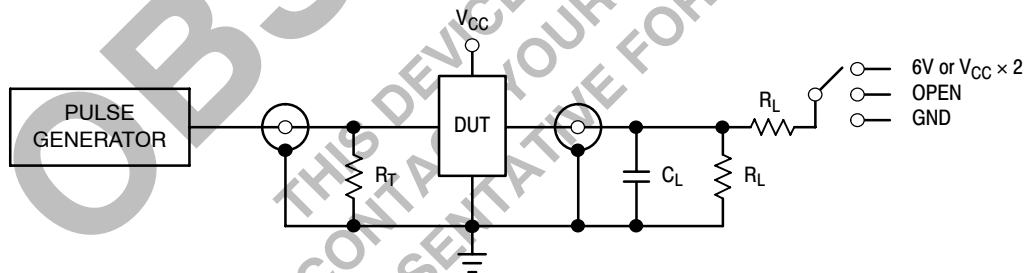


Figure 7. Test Circuit

Table 5. TEST CIRCUIT

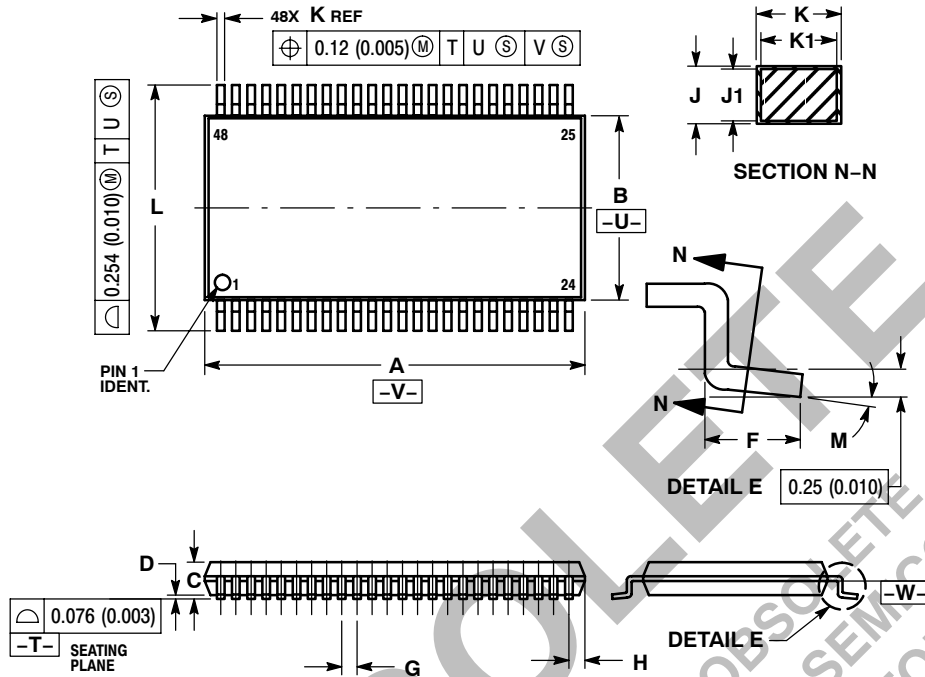
TEST	SWITCH
t_{PLH} , t_{PHL}	Open
t_{PZL} , t_{PLZ}	6 V at $V_{CC} = 3.3 \pm 0.3 \text{ V}$; $V_{CC} \times 2$ at $V_{CC} = 2.5 \pm 0.2 \text{ V}$; $1.8 \pm 0.15 \text{ V}$
t_{PZH} , t_{PHZ}	GND

$C_L = 50 \text{ pF}$ or equivalent (Includes jig and probe capacitance)
 $R_L = 500 \Omega$ or equivalent
 $R_T = Z_{OUT}$ of pulse generator (typically 50Ω)

74VCX16240

PACKAGE DIMENSIONS

TSSOP
DT SUFFIX
CASE 1201-01
ISSUE A



NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSIONS A AND B DO NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
4. DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE K DIMENSION AT MAXIMUM MATERIAL CONDITION.
5. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
6. DIMENSIONS A AND B ARE TO BE DETERMINED AT DATUM PLANE -W-.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	12.40	12.60	0.488	0.496
B	6.00	6.20	0.236	0.244
C	---	1.10	---	0.043
D	0.05	0.15	0.002	0.006
F	0.50	0.75	0.020	0.030
G	0.50 BSC		0.0197 BSC	
H	0.37	---	0.015	---
J	0.09	0.20	0.004	0.008
J1	0.09	0.16	0.004	0.006
K	0.17	0.27	0.007	0.011
K1	0.17	0.23	0.007	0.009
L	7.95	8.25	0.313	0.325
M	0°	8°	0°	8°

ON Semiconductor and are registered trademarks of Semiconductor Components Industries, LLC (SCILLC). SCILLC reserves the right to make changes without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights nor the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the SCILLC product could create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that SCILLC was negligent regarding the design or manufacture of the part. SCILLC is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:
Literature Distribution Center for ON Semiconductor
P.O. Box 5163, Denver, Colorado 80217 USA
Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada
Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada
Email: orderlit@onsemi.com

N. American Technical Support: 800-282-9855 Toll Free
USA/Canada
Europe, Middle East and Africa Technical Support:
Phone: 421 33 790 2910
Japan Customer Focus Center
Phone: 81-3-5773-3850

ON Semiconductor Website: www.onsemi.com
Order Literature: <http://www.onsemi.com/orderlit>

For additional information, please contact your local Sales Representative